

SSA-DSV650



Special **double side resist printing** model for printed circuit board



Vertical mechanism greatly saves installation space.
Automatic line is also possible.



Reflect **convenience functions and usability** from history and achievement of SERIA screen printing machine

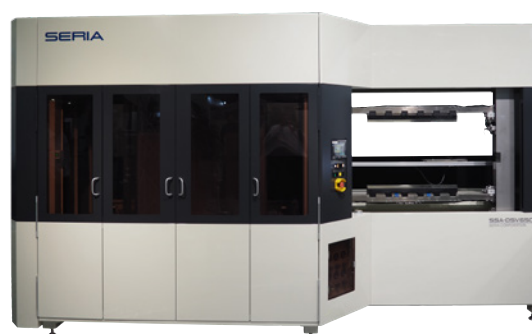
Basic Specifications

SSA-DSV650			
Max.Work Size	(W)650×(D)650 mm	Machine Dimensions	(W)3917×(D)1145×(H)2232 mm
Min.Work Size	(W)250×(D)250 mm	Machine Weight	Approx. 2000kg
Work Thickness	t 0.2 ~ 3.0 mm [※]	Power Supply	3 Phase AC200V 60Hz 1kW
Max.Work Weight	4kg	Air Supply	50ℓ/min 0.55MPa
Print Margin(Space)	Min.5 mm (Squeegee Bias Unused) It Does Not Apply When You Use Squeegee Bias.		
Frame Size	(W)1100×(D)1100 mm t 30 ~ 40 mm		
Frame Positioning	X ±10 mm Y ±10 mm		
Print Direction	From Top to Bottom		
Peel Off Stroke	20 mm Air Cylinder Type		
SQ.Back SC.Pressure	0.1 ~ 0.5MPa Manual Setting With Pressure Gauge		
SQ.Angle	±30°		
SQ.Speed	25 ~ 250 mm/sec Parameter Setting		
SQ.Stroke	800 mm		
Coat Direction	Print From Bottom to Top		
Coat Pressure	0.1 ~ 0.5MPa With Pressure Gauge		
Coat Speed	25 ~ 250 mm/sec Parameter Setting		
Coat Stroke	800 mm		
Clearance Stroke	Approx. 10 mm With Gap Adjustment Function(Front) Fine Adjustment Amount 0 ~ 3 mm		

※The thin board with less than 0.3mm thickness may not be applicable depending on the board condition.

Option Specifications

Double Slide Work Carrier	: Work Removing and Setting is Possible in Printing
SQ.Electric Down Stop	: Down Stop Stroke with Parameter Setting
SQ.Auto Printing Pressure Control	: Printing Pressure Control with Parameter Setting
Peel-Off (Electric Drive)	: CAM and Servo Motor Driving



Specification to subject be changed without notice.